

Altera Device Package Information

04R-00387-2.0

1517-Pin FineLine Ball-Grid Array (FBGA) - Flip Chip - Single-Piece Lid - A:3.40 - D1:34.1

- All dimensions and tolerances conform to ASME Y14.5M 1994.
- Controlling dimension is in millimeters.
- Pin A1 may be indicated by an ID dot, or a special feature, in its proximity on package surface.

Package Information		
Description	Specification	
Ordering Code Reference	F	
Package Acronym	FBGA	
Substrate Material	ВТ	
Solder ball composition	Regular: 63Sn:37Pb (Typ.) Pb-free: Sn:3Ag:0.5Cu (Typ.)	
JEDEC Outline Reference	MS-034 Variation: AAU-1	
Lead Coplanarity	0.010 inch (0.25 mm)	
Weight	15.2 g (Typ.)	
Moisture Sensitivity Level	Printed on moisture barrier bag	

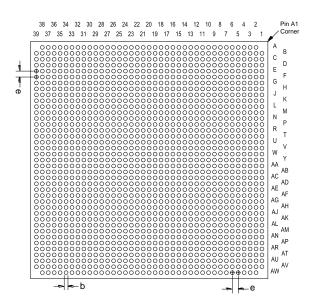
Package Outline D	ackage Outline Dimension Table				
Compleal	Millimeters				
Symbol	Min.	Nom.	Max.		
Α	3.00	3.20	3.40		
A1	0.40	0.50	0.60		
A2	2.40	2.70	3.00		
А3	1.30	1.40	1.50		
D	40.00 BSC				
D1	34.10 BSC				
E	40.00 BSC				
E1	33.00 BSC				
b	0.50	0.60	0.70		
е	1.00 BSC				

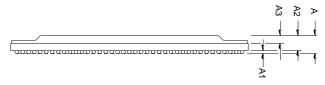
Package Outline

TOP VIEW

Pin A1 ID

BOTTOM VIEW





Document Revision History

Table 1 shows the revision history for this document.

Table 1. Document Revision History

Date	Version	Changes
May 2011	1.0	Initial release
June 2013	2.0	Change the coplanarity tolerance from 0.008 inch to 0.010 inch per JEDEC Standard MS-034D.



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